

FS50VSJ-3

HIGH-SPEED SWITCHING USE

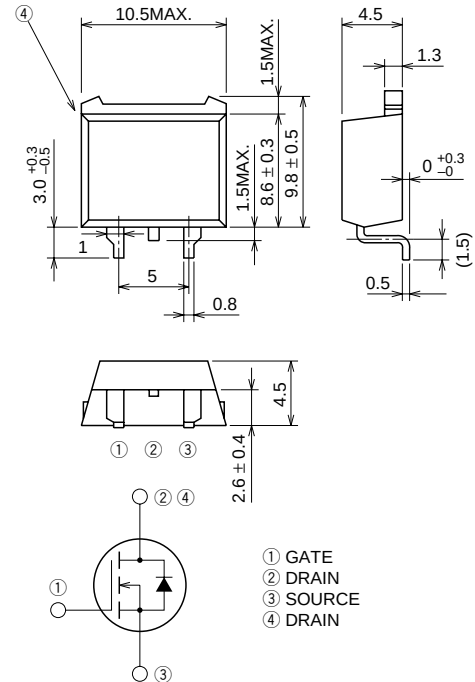
FS50VSJ-3



- 4V DRIVE
- V_{DS} 150V
- $r_{DS(ON)}$ (MAX) 30m Ω
- I_D 50A
- Integrated Fast Recovery Diode (TYP.) 125ns

OUTLINE DRAWING

Dimensions in mm



TO-220S

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (Tc = 25°C)

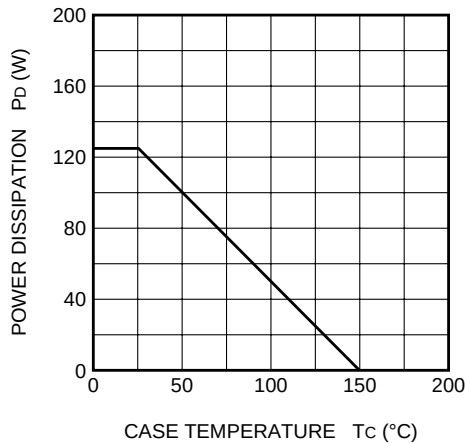
Symbol	Parameter	Conditions	Ratings	Unit
V_{DS}	Drain-source voltage	$V_{GS} = 0V$	150	V
V_{GS}	Gate-source voltage	$V_{DS} = 0V$	± 20	V
I_D	Drain current		50	A
I_{DM}	Drain current (Pulsed)		200	A
I_{DA}	Avalanche drain current (Pulsed)	$L = 100\mu H$	50	A
I_S	Source current		50	A
I_{SM}	Source current (Pulsed)		200	A
P_D	Maximum power dissipation		125	W
T_{ch}	Channel temperature		-55 ~ +150	°C
T_{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	1.2	g

ELECTRICAL CHARACTERISTICS (T_{ch} = 25°C)

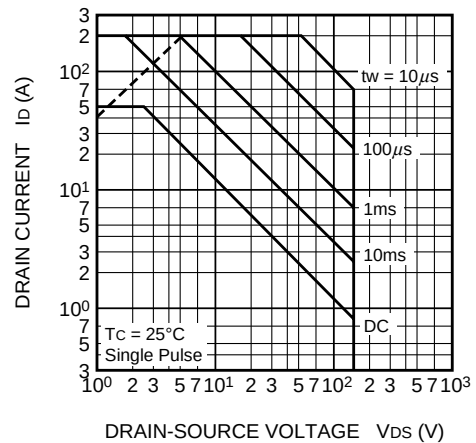
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0V	150	—	—	V
I _{GSS}	Gate-source leakage current	V _{GS} = ±20V, V _{DS} = 0V	—	—	±0.1	μA
I _{DSS}	Drain-source leakage current	V _{DS} = 150V, V _{GS} = 0V	—	—	0.1	mA
V _{GS(th)}	Gate-source threshold voltage	I _D = 1mA, V _{DS} = 10V	1.0	1.5	2.0	V
r _{DS(on)}	Drain-source on-state resistance	I _D = 25A, V _{GS} = 10V	—	23	30	mΩ
r _{DS(on)}	Drain-source on-state resistance	I _D = 25A, V _{GS} = 4V	—	24	32	mΩ
V _{DS(on)}	Drain-source on-state voltage	I _D = 25A, V _{GS} = 10V	—	0.58	0.75	V
y _{fs}	Forward transfer admittance	I _D = 25A, V _{DS} = 10V	—	62	—	S
C _{iss}	Input capacitance	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz	—	8200	—	pF
C _{oss}	Output capacitance		—	870	—	pF
C _{rss}	Reverse transfer capacitance		—	440	—	pF
t _{d(on)}	Turn-on delay time	V _{DD} = 80V, I _D = 25A, V _{GS} = 10V, R _{GEN} = R _{GS} = 50Ω	—	54	—	ns
t _r	Rise time		—	110	—	ns
t _{d(off)}	Turn-off delay time		—	850	—	ns
t _f	Fall time		—	340	—	ns
V _{SD}	Source-drain voltage	I _S = 25A, V _{GS} = 0V	—	1.0	1.5	V
R _{th(ch-c)}	Thermal resistance	Channel to case	—	—	1.00	°C/W
t _{rr}	Reverse recovery time	I _S = 50A, di _S /dt = -100A/μs	—	125	—	ns

PERFORMANCE CURVES

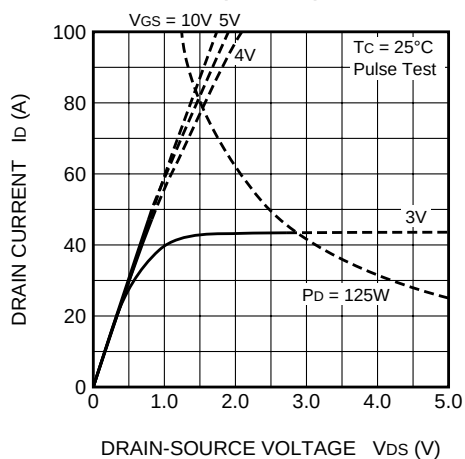
POWER DISSIPATION DERATING CURVE



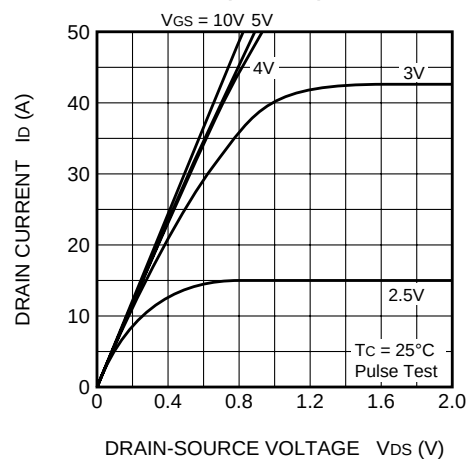
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)

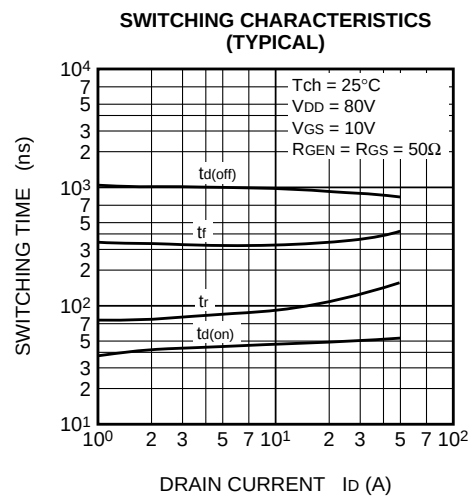
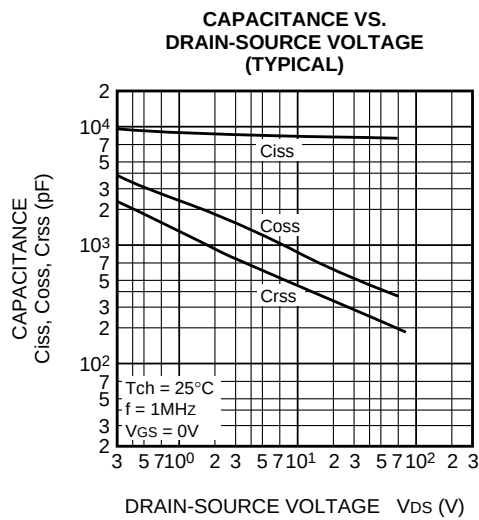
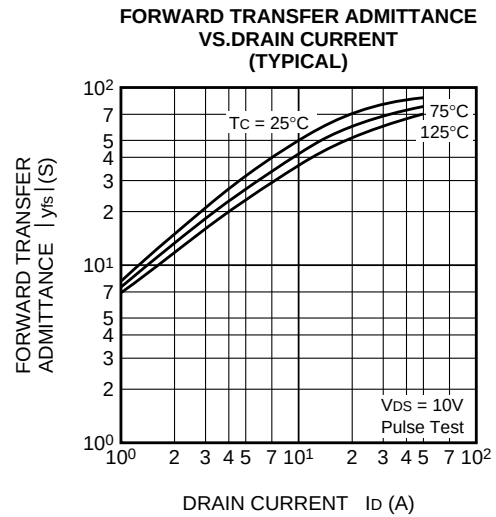
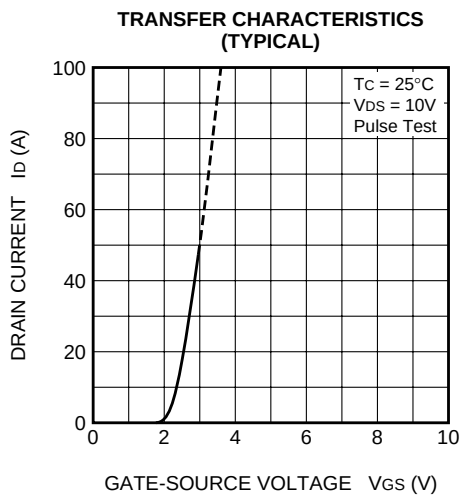
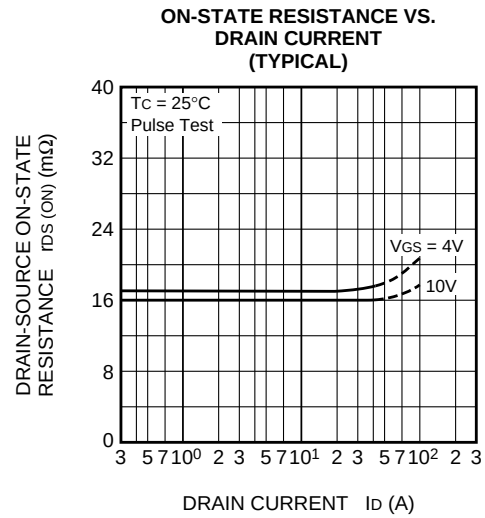
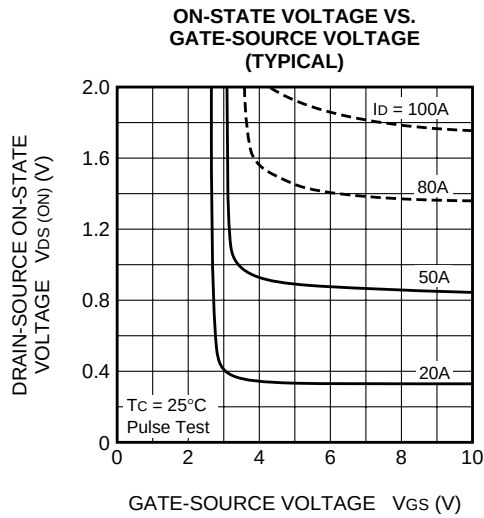


OUTPUT CHARACTERISTICS (TYPICAL)

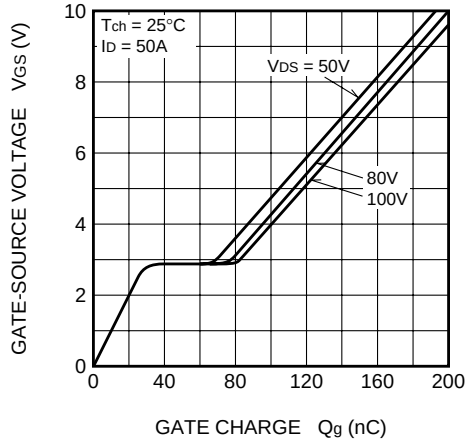


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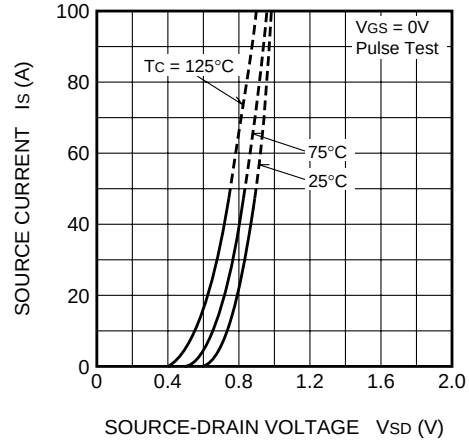
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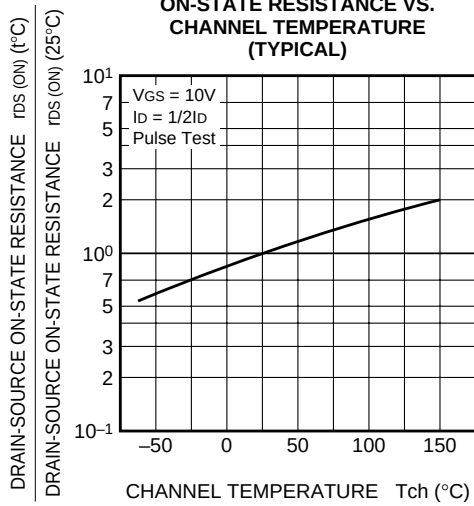
GATE-SOURCE VOLTAGE
VS. GATE CHARGE
(TYPICAL)



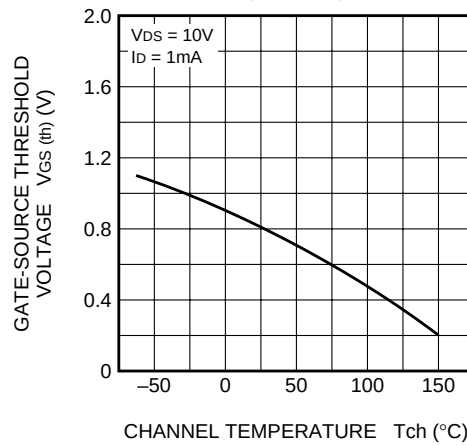
SOURCE-DRAIN DIODE
FORWARD CHARACTERISTICS
(TYPICAL)



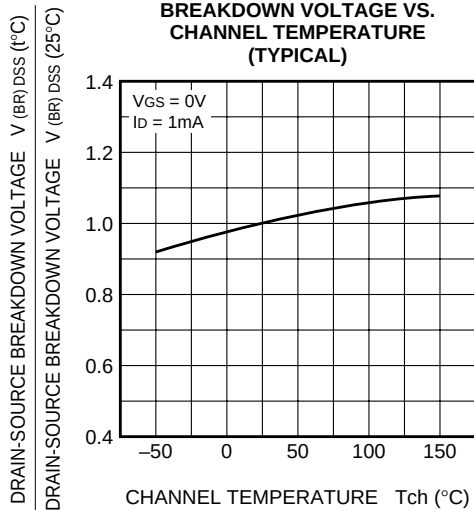
ON-STATE RESISTANCE VS.
CHANNEL TEMPERATURE
(TYPICAL)



THRESHOLD VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



BREAKDOWN VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



TRANSIENT THERMAL IMPEDANCE
CHARACTERISTICS

